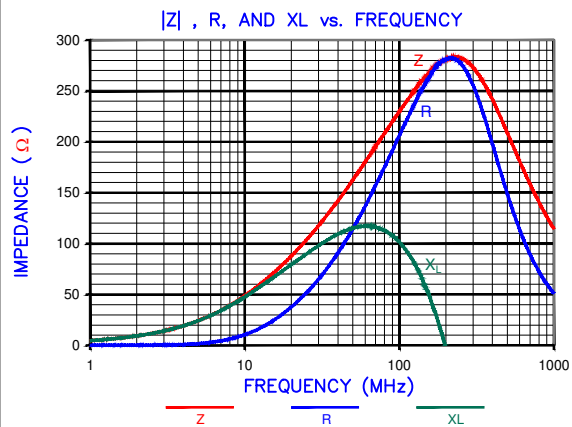
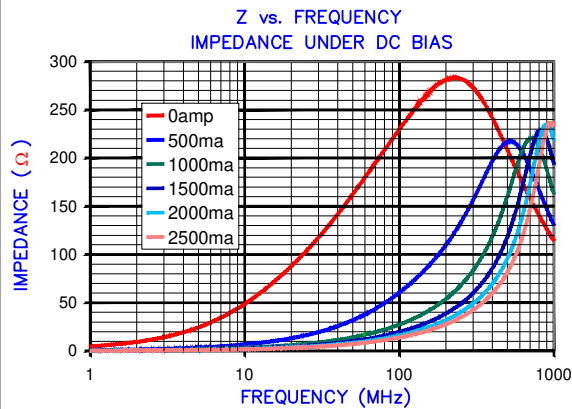
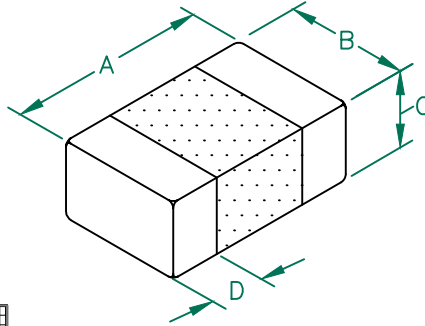


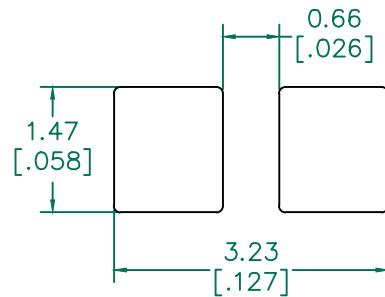
HI0805N221R-10

PHYSICAL DIMENSIONS:

A	2.00 [.079]	+ 0.20 [.008]
B	1.25 [.049]	+ 0.20 [.008]
C	0.90 [.035]	+ 0.20 [.008]
D	0.51 [.020]	+ 0.25 [.010]

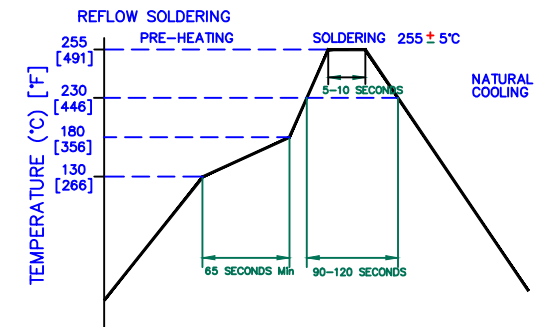


LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS



ELECTRICAL CHARACTERISTICS:

Z @ 100MHz (Ω)	DCR (Ω)	Rated Current
Nominal	220	
Minimum	165	
Maximum	275	0.04
		3000 mA

NOTES: UNLESS OTHERWISE SPECIFIED

1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPE.
2. TERMINATION FINISH IS 100% TIN.
3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
4. OPERATING TEMPERATURE: -40°C~+125°C. (INCLUDING SELF-HEATING)
5. COSMETIC SPECIFICATION REFER TO WI-QA-124.

RoHS

AGILENT E4991A RF Impedance/Material Analyzer
HP 16092A Test Fixture. TEST REF. 3124

REV		DESCRIPTION	DATE	INT	QU
A		ORIGINAL DRAFT	06/10/12	QU	

DIMENSIONS ARE IN mm [INCHES].		This print is the property of Laird Tech. and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.		
PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:	
HI0805N221R-10	A	CO-FIRE	QU	
DATE:	SCALE:	SHEET:		
06/10/12	-	1 of 1		
CAD #	TOOL #			
HI0805N221R-10-A	-			